

# **WS2813B** Ver. No.: V5

**Intelligent control LED integrated light source** 

#### **Features and Benefits**

- The control circuit and RGB chip are integrated in a 5050 components, to form an external control pixel.
- Intelligent Reverse-connection protection.
- Using the built-in signal reshaping circuit to achieve the signal waveform shaping, and no distortion of waveform of signal takes place.
- The gray levels of each pixel are of 256 levels, which achieves "256\*256\*256=16777216" full-color display, and the refresh frequency reaches to 2KHz.
- Serial cascade interface, data receiving and decoding depend on just one signal line.
- Dual-signal wires version, One additional signal line is added to realize double signal transmission signal break-point continuous transmission. Any single pixel failure won't affect the overall display effect.
- Any two point the distance more than 5M transmission signal without any increase circuit.
- When the refresh rate is 30fps, cascade numbers is at least 1024 pixels.
- Data transmitting at speeds of up to 800Kbps.
- Good color consistency reliability, high cost-effective.
- NO extra components needed, even the capacitor.

#### **Applications**

- Consumer Electronics.
- Landscape lighting fields.
- Computer peripheral products, games devices and machinery equipment etc.

#### **General description**

WS2813B-V5 is an intelligent control LED light source that the control circuit and RGB chip are integrated in a package of 5050 components. Its internal include intelligent digital port data latch and signal reshaping amplification drive circuit. Also include a precision internal oscillator and voltage programmable constant current control part, which achieves highly consistent color effect.

**Double channel Dual-signal wires version,** signal break-point continuous transmission. Any pixel's failure won't affect signal transfer and overall emitting color effect.

The data transfer protocol use single NZR communication mode. After the pixel power-on reset, the DIN port receive data from controller, the first pixel collect initial 24bit data then sent to the internal data latch, the other data which reshaping by the internal signal reshaping amplification circuit sent to the next cascade pixel through the DO port. After transmission for each pixel, the signal to reduce 24bit. Every pixel adopts auto-reshaping transmit technology, making the pixel cascade numbers are not limited to the signal transmission, only relate to the speed of signal transmission.

Refresh Frequency updates to **2KHz**, No flicker occurs even when captured by hd camera, which is very suitable for the use of HD Video Camera.

RESET time>280μs, it won't cause wrong reset while interruption, it supports the lower frequency and inexpensive MCU.

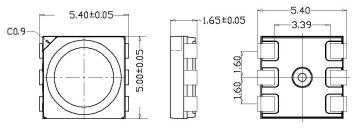
Integrated circuit chips enable the circuit control simpler, neater and more reliable while NO extra components needed.

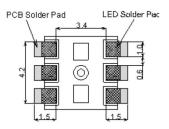


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#### **Mechanical Dimensions**

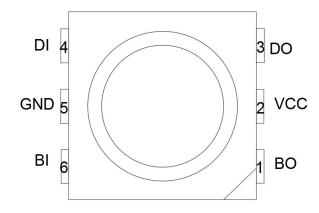




#### **♦** Remarks

Dimension: 5.0\*5.4\*1.65mm
 Default tolerance: ±0.05mm

### **PIN Configuration**



#### **PIN Function**

NO.	Symbol	PIN	Function description		
1	во во		Backup data signal output		
2	VCC	VCC	LED POWER SUPPLY, connect to "+5V"		
3	DO	DO	Control data signal output		
4	DIN DIN		Control data signal input		
5	GND	GND	Data & Power Grounding		
6	BIN	BIN	Backup Control data signal input		

### **Absolute Maximum Ratings**(T<sub>A</sub>=25°C,V<sub>SS</sub>=0V)

Parameter	Symbol	Ratings	Unit
Power supply voltage	VCC	+3.7~+5.3	V
Logical Input Voltage	V <sub>I</sub>	-0.3V~VDD+0.7V	V

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# Electrical Characteristics (T<sub>A</sub>=25°C, Vcc=5V, V<sub>SS</sub>=0V)

Parameter	Symbol	Min.	Тру.	Max.	Unit	Conditions
Input Current	$I_{\rm I}$			±1	μΑ	V <sub>I</sub> =VDD/VSS
High-level Input	V <sub>IH</sub>	2.7V		VDD+0.7V	V	D <sub>IN</sub> , SET
Low-level Input	$V_{ m IL}$	-0.3V		0.7V	V	D <sub>IN</sub> , SET

## Switching Characteristics (T<sub>A</sub>=25°C, Vcc=5V, V<sub>SS</sub>=0V)

Parameter	Symbol	Min	Тру	Max	Unit	Condition
Transmission Delay Time	$T_{PLZ}$			300	ns	CL=15pF, DIN→DOUT, RL=10KΩ
Fall time	$T_{THZ}$			120	μs	CL=300pF, OUTR/OUTG/OUTB
Input-capacitance	CI			15	pF	

#### **LED Characteristics**

Davamatav	Crymbal	Color		Quiescent Cu	Condition			
Parameter	Symbol	Color	Min	Tpy	Max	Unit	(Working current)	
Brightness IV		RED	300	380	600			
	IV	IV	GREEN	800	1050	1500	mcd	16mA
		BLUE	200	270	400			
		RED	620	623	630			
Wavelength	λd	GREEN	510	520	520	nm	16mA	
		BLUE	465	471	475			

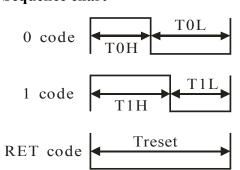
#### **Data Transfer Time**

ТОН	0-code, High-level time	220ns~380ns			
Т1Н	1-code, High-level time	580ns~1μs			
TOL	0-code, Low-level time	580ns~1μs			
T1L	1-code, Low-level time	580ns~1μs			
RES	Frame unit, Low-level time	> 280µs			

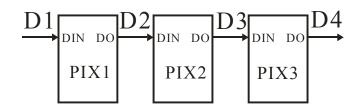
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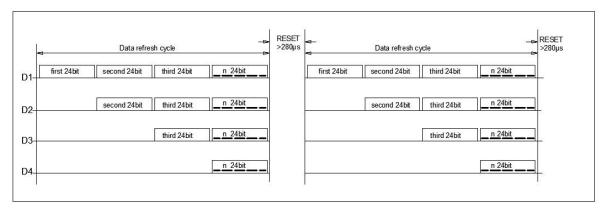
#### **Sequence chart**



#### Cascade method



#### **Data Transmission Method**



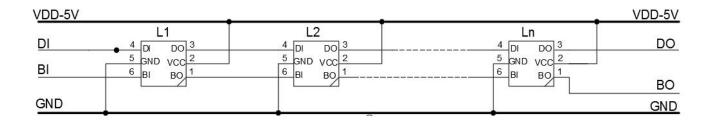
Note: D1 is the data from MCU, and D2, D3, D4 are from Cascade Circuits.

#### Composition of 24bit data

G7 G6 G5 G4 G3 G2 G1 G0 R7 R6 R5 R4 R3 R2 R1 R0 B7 B6 B5 B4 B3 B2 B1																								
	G7	G6	G5	G4	G3	G2	G1	G0	R7	R6	R5	R4	R3	R2	R1	R0	В7	В6	В5	B4	В3	B2	B1	В0

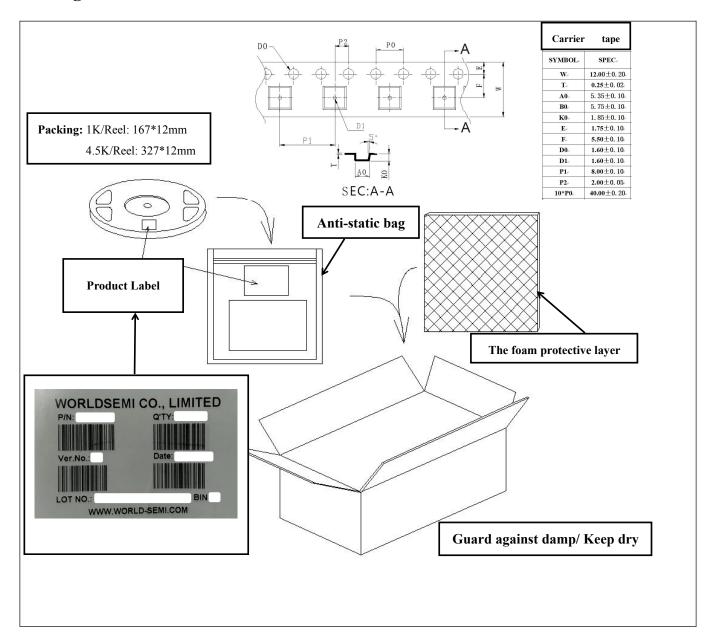
Note: Data transmit in order of GRB, high bit data is first.

#### Typical application circuit



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# **Packing Standard**



# **Top SMD LED Using Instructions**

#### 1. **Summary**

To make the best use of WORLDSEMI's LED, please refer to the below precautions, they are of same usage method as other electronic components.



#### **Cautions**

#### 2.1. Dust & Cleaning

The surface of the LED is encapsulated with modified epoxy resin because it plays a very good role in protecting the optical performance and aging resistance. The modified epoxy resin is easy to stick with dust and must be kept clean. When there's a certain amount of dust on the surface of the LED, it won't affect brightness, but dust proof should be taken care of. Promoting the use of unsealed package in preference to others and the assembled LEDs should be placed in a clean container.

Avoid using the organic solvents to clean the dust on the LED surface and it's necessary to confirm whether the cleaning fluid will dissolve the LED.

Do not clean the LEDs by the ultrasonic. Some parameters affecting the LED performance must be evaluated if have no alternative but to the ultrasonic cleaning method, such as ultrasonic power, baking time and assembly conditions, etc.

#### 2.2. Moisture-proof packaging

TOP SMD LEDs are moisture sensitive components. LEDs are packaged in aluminum foil bag to prevent the from absorbing moisture during transport and storage. A desiccant is placed in the bags to absorb moisture. If the LED absorbs moisture, then it evaporates and expands when in reflow process, which may break the colloid from the bracket and damage the optical performance of LED. For this reason, moisture-proof packaging is to prevent the from absorbing moisture during transport and storage. The moisture resistance rating of WORLDSEMI's LED is: LEVEL 5a.

Tabel I - IPC/JEDEC J-STD-020 Moisture/Reflow Sensitivity Classification

MSL Level	Workshop Life						
WISE Ecver	Time	Conditions					
LEVEL1	Unlimited	≤30°C/85%RH					
LEVEL2	1 Year	≤30°C/60%RH					
LEVEL2a	4 Weeks	≤30°C/60%RH					
LEVEL3	168 Hours	≤30°C/60%RH					
LEVEL4	72 Hours	≤30°C160%RH					
LEVEL5	48 Hours	≤30°C/60%RH					
LEVEL5a	24 Hours	≤30°C/60%RH					
LEVEL6	Take-out and Use immediately	≤30°C/60%RH					

#### 2.3. Management after unpacking

- 1. Please use the LED under the condition of "T<30°C, RH<60%".
- 2. Use up within 24 hours after removing from packages.
- 3. We would recommend to do dehumidification if they exceed the valid storage period of products or dampened due to other reasons.

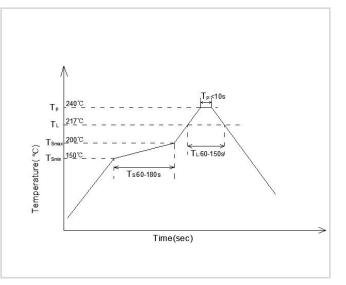
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2.4. Dehumidification Operation (Non-leakage of air, baking temperature: 70°C-75°C >24H)

#### 3. SMT Reflow

Refer to the parameters listed below, the experimental results prove that the TOP SMD LED meets the JEDEC J-STD-020C standards. As a general guideline, it is recommended to follow the SMT reflow temperature curve recommended by the solder paste manufacturer.

Curve Description	Lead-free
The lowest preheat temperature (Tsmin)	150℃
The highest preheat temperature (Tsmax)	200℃
Preheating time (Tsmin to Tsmax) (ts)	60-180 S
Average rate of temperature rise (Tsmax to Tp)	<3°C/S
LIQUID REGION temperature (TL)	217℃
LIQUID REGION Holding Time (tL)	60-150 S
Peak Temperature (Tp)	240℃
High Temperature Region(Tp=-5℃) Holding	<10 S
Cooling Rate	<6°C/S
Room Temperature to Peak Holding Time	<6 min



Remarks: 1. These general guidelines may not apply to all PCB designs and reflow soldering configurations.

2. All temperatures referred are measured on the surface of the package body.

#### 4. Assembly Precautions

1. Clip the LED from its	2. Neither directly touch the gel	3. Not to be double stacked, it may	4. Can not be stored in or applied
side.	surface with the hand or sharp	damage its internal circuit.	in the acidic sites of PH<7.
	instrument, it may damage its		
	internal circuit.		
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### **Modify Record**

Version №	Status Bar	<b>Modify Content Summary</b>	Date	Reviser	Approved
V1.0	N	New	20170523	Shen JinGuo	Yin HuaPing
V1.1	M	Absolute Maximum Ratings	20171009	Shen JinGuo	Yin HuaPing
V1.2	M	Maximum ratings, Data Transfer Time	20180207	Shen JinGuo	Yin HuaPing
V2.0	M	"The transparent sealing silica gel" changed to "The opaque Modified Epoxy Resin". Refers to PRECAUTIONS	20180412	Shen JinGuo	Yin HuaPing
V3.0	M	Logical Input Voltage; Brightness adjustment; Precautions	20180719	Shen JinGuo	Yin HuaPing
V4.0	M	Driver IC upgraded; No extra components needed.	20190423	Shen JinGuo	Yin HuaPing
V5.0	M	On the basis of V4.0, enhance the drive IC internal filtering effect, remove the LED internal packaging capacitance	20191020	Shen JinGuo	Yin HuaPing

#### Remarks:

- 1. Initial version: V1.0; Parameter added or modified, version number plus "0.1", for example: V1.0→ V1.1
- 2. Major version design or more parameters modified, version number plus "1.0", for example: V1.0→V2.0
- 3. With no version number attached to part number
- 4. Status bar: N--New, A--Add, M--Modify, D--Delete